

Product Data Sheet Type: IS560

Group: ACCESSORIES Thermal Interface Material

Insulation bushings

Temperature resistance :	130 °C
Electrical insulating :	30 kV
Thickness :	0,2
Inner diameter :	3.1
Outer diameter :	3.5
Diameter :	6
For device :	TO220 TO218 (TOP3) Multi
Device mounted by :	Screw
Material :	Makrolone



Insulating bush

in combination with insulating wafers from mica or silicone foil facilitate insulated mounting of semiconductors to heat sinks or other components

